# AN10936

Photovoltaic MPPT battery charge controller using the MPT612 IC reference board

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**Application note** 

### **Document information**

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| Abstract | This application note describes how to develop a buck-boost enabled solar PV MPPT charge controller using the MPT612 reference board. In addition, it describes how to test and benchmark the controller with other designs. |



### **Revision history**

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| 2.0 | 20110202 | <ul> <li>Graphics updated: Figure 9(a), Figure 9(b), Figure 10(a), Figure 10(b), Figure 11,<br/>Figure 12, Figure 13.</li> </ul> |
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# 1. Introduction

# **1.1** Solar photovoltaic energy and maximum power point

Dwindling fossil fuel resources and the adverse environmental effects arising from converting these resources into energy have placed increasing focus on the use of non-fossil fuel energy sources such as solar energy.

Solar illumination can be converted into electrical energy through solar cells and the energy generated is called PhotoVoltaic (PV) energy. While the sun as a source is available for free, generating PV energy is expensive. This makes it important to extract the maximum PV energy from the incident sun light using the solar cells.

Typical solar cells comprise a PN junction made of a semiconductor material such as silicon. Since the power from a single cell is too small to be of practical use, cells are connected in series-parallel fashion to realize higher power, voltage and current. These are called solar panels or modules. PV panels are rated in terms of peak-watt at standard test conditions (25 °C, 1000 W/m<sup>2</sup> power density and spectrum of AirMass 1.5).



A solar PV panel has the current/voltage/power characteristics shown in Figure 1.

There is a specific PV voltage at which the power delivered by the PV panel is the highest. On the curve the point at which the power is the maximum is called the power at the maximum power point ( $P_{MPP}$ ) or peak-watt (WP). The voltage at MPP is called the maximum power point voltage ( $V_{MPP}$ ) and the current is called the maximum power point current ( $I_{MPP}$ ). In Figure 1,  $P_{MPP}$  is 70 W,  $V_{MPP}$  is 16.2 V and  $I_{MPP}$  is 4.3 A.

If the solar panel operates at its MPP, maximum power can be extracted from the panel. Operating the panel at any other point amounts to under utilization of the PV power available and thus inefficient use of expensive PV power. Tracking the MPP of a PV panel (DC source) is called the Maximum Power Point Tracking (MPPT). MPPT and ensuring that the panel operates at this MPP helps maximum utilization of the installed PV capacity.

# **1.2 Solar charge controller**

The PV power extracted can be used:

- To directly power a DC load
- To be converted to AC using an inverter to drive an AC load
- To charge an energy storage device (battery, super capacitor etc.) enabling the power to be used on demand

This application note focuses on charging batteries from a PV panel using an MPPT-enabled charge controller.

Typically a charge controller performs the following basic functions:

- Controls maximum power extraction from a panel by tracking the MPP and ensuring that the panel operates at MPP
- Controls battery charging as defined in the battery charge cycle specification to improve usable battery life and protect it against reverse connection, over charging and deep discharging
- Load protection against overloads and short-circuits
- LED or LCD Status indications
- Communication of system parameters to external systems using dedicated interfaces

Depending on the topology of the power electronics, an MPPT charge controller can be either:

- Buck only the PV voltage must be higher than the battery voltage
- Boost only the PV voltage must be lower than battery voltage
- **Buck-boost** both the PV voltage and battery voltage can be variable values with the system switching between buck and boost based on the relative voltages

A simplified illustration of a solar battery charging system is shown in Figure 2.

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# 2. MPT612 IC

The MPT612 is an IC developed for Maximum Power Point Tracking (MPPT) applications to extract the maximum power from a source such as a PV panel or fuel cell. The ICs primary function is to track the MPP of the source based on the voltage and current. The resulting Pulse-Width Modulated (PWM) output is sent to the MOSFET to control the device switching, enabling the system to operate at MPP.

Utilizing a patent pending MPPT algorithm defined in the embedded software, the MPT612 provides up to 15 kB of on-chip high-speed flash memory enabling enhanced functionality using user software. Serial communication interfaces such as UART, SPI, SSP and I<sup>2</sup>C-bus make the MPT612 ideally suited for integrating with real world systems.

The MPT612 is based on the ARM7TDMI-S 32-bit RISC core and operates at up to 70 MHz. Housed in a 48-pin LQFP IC package, the MPT612 provides a number of standard software libraries for implementing the PV MPPT function and several other optional functions as shown in <u>Figure 3</u>. See the *MPT612 data sheet* for full details on the MPT612.



# 3. MPT612 software

The MPT612 is bundled together with the software libraries for the MPPT function. The high level software architecture of the IC is shown in Figure 4.



The MPT612's software consists of the following:

- Hardware Functional Abstraction Layer:
  - This layer contains the abstraction of services for different peripherals
  - Will be used by the different layers including MPPT Core and other application layers
  - This layer exports APIs for registering the callbacks that will be called periodically
  - APIs are exported for peripherals such as ADC, PWM, interrupts/UART and functions that are helpful in application layers such as software timer

### • MPPT Core:

- MPPT Core is the main layer that implements the MPPT algorithm (patent pending)
- This layer always tracks the MPP (Maximum Power Point) when enabled
- The APIs exported by this block, should be called by the application to control the functionality of the MPPT Core
- The application over this layer sends the configuration to the MPPT Core, which in turn works within those configuration parameters

The optional lead-acid battery charging module is explained in the *MPT612 data sheet*. This software is also used in the MPPT charge controller reference design.

The application software developed for the MPPT charge controller reference design has the following features:

- This application software implements the product requirements for a sample charge controller that controls the load and charges the battery
- The main functionality of this software invokes the MPPT Core and lead-acid battery charging layers at an appropriate time as required. This application manages the safety check of the system
- It also indicates the status of the charge controller
- Logs the relevant data into flash memory for further action

# 3.1 Software memory size

### Table 1.Software memory size

| Part  | Memory type         | Size                   |
|---|---------------------|------------------------|
| Total memory in MPT612 IC                   | flash memory        | 32 kB                  |
|   | SRAM                | 8 kB                   |
| Memory used for HFAL, MPPT Core and lead-ac | id battery charging | , excluding debug code |
| MPPT Core (whole layer)                     | ROM                 | 7 kB                   |
|   | RAM                 | 1.2 kB <sup>[1]</sup>  |
| HFAL  | ROM                 | 8 kB[2]                |
|   | RAM                 | 1.2 kB                 |
| Lead-acid battery charging module           | ROM                 | 3.5 kB                 |
|   | RAM                 | 1.2 kB                 |
|   |                     |                        |

[1] 1 kB is allocated for stack, which may be reduced.

[2] Includes scheduler, PWM, ADC, IRQ, GPIO, timer, flash, data logging, LED module etc.

# 4. MPPT charge controller reference system

The MPT612 and its associated software functionality can be demonstrated using an MPPT enabled solar battery charge controller. This application note describes the design and development of a charge controller specifically focusing on making optimal use of the features and functionality of the MPT612 IC and software.

The charge controller takes power from a solar PV panel and charges the battery as defined in the battery charge cycle specification. It also enables the battery supplying power to the DC loads connected to the controller. Apart from this, a number of protection mechanisms, system status indications, configurability and communication facilities are implemented.

To ensure ease and safe use, a number of configuration parameters are available which control protection mechanisms, system status indications and communication interfaces.

# 4.1 System specifications

The charge controller specifications are described in Table 2.

|                                | Jan Jan                                 |
|--------------------------------|---|
| Feature and parameter          | Value                                   |
| Input                          |   |
| Minimum input voltage at MPP*  | 10 V                                    |
| Nominal PV voltage             | 12 V                                    |
| Maximum PV voltage*            | 27 V                                    |
| Maximum PV current             | 6 A                                     |
| Maximum PV module power rating | 100 W                                   |
| Connector type                 | 2-terminal; screw type                  |
| Battery                        |   |
| Battery type*                  | lead-acid                               |
| Nominal battery voltage        | 12 V                                    |
| Maximum charging current       | 6 A                                     |
| Charge cycle*                  | 3-stage in CC and CV modes define modes |
| Battery boost on voltage*      | $12.7~V\pm0.3~V$                        |
| Battery boost off voltage*     | $15.3~V\pm0.3~V$                        |
| Battery float on voltage*      | $13.8~V\pm0.3~V$                        |
| Battery float off voltage*     | $14.6 \text{ V} \pm 0.3 \text{ V}$      |
| Load disconnect voltage*       | $10.8~V\pm0.3~V$                        |
| Load reconnect voltage*        | $12.2~V\pm0.3~V$                        |
| Battery low alarm on voltage*  | 11.4 V $\pm$ 0.3 V                      |
| Battery low alarm off voltage* | 11.6 V $\pm$ 0.3 V                      |
| Connector type                 | 2-terminal; screw type                  |

Table 2.MPPT charge controller reference design specifications $T_{amb} = 25$  °C; parameters marked with \* can be configured.

| Feature and parameter   | Value   |
|---|---|
| Load  |   |
| Load DC voltage   | same as battery voltage                               |
| Maximum load current  | 8 A   |
| Number of load connectors                                       | 2   |
| Load connector type   | 2-terminal; screw type                                |
| Protection functions  |   |
| PV reverse polarity protection                                  | yes   |
| PV reverse current flow protection                              | yes   |
| Surge/transient protection                                      | 1.5 kVA   |
| Stop charging at high temperature*                              | 50 °C   |
| Battery low voltage/deep discharge protection*                  | 10.8 V  |
| Battery reverse polarity protection                             | yes; 12 A fuse  |
| Battery short-circuit protection                                | yes; 12 A fuse  |
| Battery open protection   | yes; system is not on if the battery is not connected |
| Load cut-off current overload for 500 ms*                       | 10 A  |
| Load cut-off current short-circuit                              | 10 A  |
| Indicators  |   |
| System status indication (3 LEDs)                               | green blinking: battery fully charged                 |
|   | green on: battery charging                            |
|   | yellow blinking: battery low                          |
|   | red on: battery low or overload cut-off               |
| Self consumption  |   |
| Maximum controller standby current; no load; PV voltage is zero | 10 mA   |
| Configuration   |   |
| System reset  | push button switch                                    |
| Configuration methodology                                       | via UART  |
| Communication   |   |
| Data readout  | via UART  |
| Environmental   |   |
| Ambient temperature range                                       | 0 °C to 50 °C   |

**Table 2.MPPT charge controller reference design specifications** ... continued $T_{amb} = 25$  °C; parameters marked with \* can be configured.

# 4.2 MPPT charge controller reference system block

The block diagram of the MPPT charge controller reference system is shown in Figure 5. The major functions of the reference design are sensing/measuring PV voltage and current, MPPT algorithm implementation (including PV power calculation, tracking the maximum power dynamically and ensuring that the required PWM output is supplied to the gate drive circuit of the switching MOSFET), DC–DC conversion using the buck-boost topology (which incorporates switching between buck and boost operation based on the relative voltage levels of PV and battery), load current sense and overload protection, system configuration (as needed through the UART) and communication of salient parameters to user as required.

In addition, the charge controller system temperature is measured and battery charging stopped, if the controller's ambient temperature rises above a certain predefined value (50 °C in this example).



# 5. Schematics

# 5.1 Charge controller reference system boards

The MPT612 MPPT charge controller reference system is implemented using a 2-board approach to minimize the charge controller Bill Of Materials (BOM) and cost.

- The charge controller board takes PV power, charges the battery and supplies power to loads
- The JTAG/UART add-on board is used exclusively for configuration and data logging

The charge controller board is needed for every PV system. However, the JTAG/UART add-on board is typically used by service providers sparingly. One JTAG/UART add-on board can be used with multiple charge controller systems. Separating the JTAG/UART configuration and data logging functionality from the main PV charge controller reduces the size and cost of the charge controller board.

<u>Figure 6</u> shows the charge controller reference system with the charge controller board and the JTAG/UART add-on board connected.



# Fig 6. Charge controller reference system

# 5.1.1 Charge controller board

The charge controller board takes the required input from the PV panel, supplies the charging current to the battery and facilitates load supply from battery to load. It also implements all protection functions as specified in Table 2 on page 9.

This charge controller board has one 8-pin input connector used for interfacing to all the external systems (such as the PV panel, battery and loads).

The optional JTAG/UART add-on board can be connected to the JTAG/UART connector to enable system configuration and data retrieval.

The charge controller board is shown in Figure 7.

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### 5.1.2 JTAG/UART add-on board

The add-on board is needed for configuring any of the configurable parameters (highlighted with an \* in <u>Table 2 on page 9</u>). This add-on board is also needed for extracting any data/information like PV voltage, current, and power from the charge controller for analytical purposes.

The JTAG/UART add-on board is shown in Figure 8.



# 5.2 Charge controller reference system; major circuit blocks

Major circuit blocks of the charge controller board are:

- PV voltage and current sense circuit
- Battery voltage and current sense circuit
- DC-DC buck-boost converter power electronics circuit
- MPT612 digital circuit
- Board power supply circuit
- JTAG/UART optional add-on circuit

### 5.2.1 PV voltage and current sense circuit

The PV voltage and current sense circuit is shown in <u>Figure 9</u>. Input to the PV voltage sense circuit is from resistor dividers R3 and R5 shown in <u>Figure 11</u>. Two separate PV voltage sense circuits are used: buck mode and boost mode voltage sense.

- **Boost mode:** quad op amps U4A and U4B with associated circuits are used for the PV voltage sense in boost mode with a gain of 1.1.
- Buck mode: quad op amp U4C is used for PV voltage sense in buck mode with a gain of 2.

Accurate measurement of PV current is important for latching to the maximum power point. The current monitor IC U14 with a gain of 50 is used for PV current sense. The low-pass filters formed by quad op amps U4A and U4D with their associated circuits are used for filtering the noise.



# 5.2.2 Battery voltage and current circuit

The battery voltage and current sense circuit is shown in <u>Figure 10</u>. The battery voltage sense circuit input is generated by the resistor divider R4 and R7 shown in <u>Figure 11</u>. The battery voltage sense circuit comprises quad op amp U5B and its associated circuits which operate with a gain of 1.1. A low-pass filter formed by quad op amp U5C and its associated circuit removes the noise.

U5A operates as a battery overvoltage indication circuit. The BAT\_overvoltage signal is used to cut-off the PWM if battery overvoltage level is reached. The op amps U6A and U6B with their associated circuits perform battery current sensing.

A 2-stage amplifier is used to enhance the signal. The 1st stage operates with a gain of 5 and the 2<sup>nd</sup> stage operates with a gain of 10. Op amp U6C is a low-pass filter for removing the signal noise.



# 5.2.3 DC-DC buck-boost converter power electronics circuit

The DC-DC buck-boost converter power electronics circuit is shown in <u>Figure 11</u>. The buck-boost converter can operate in buck-boost mode or buck-only mode. It comprises MOSFETs (Q1, Q3, Q4), Schottky rectifier D2 and inductor L1.

When the system is in boost mode, MOSFET Q3 is closed and MOSFET Q4 is open. In buck mode, Q4 is closed and Q3 is open. Capacitors C4 and C7 filter the output. Input bulk capacitors C3 and C5 store energy when switching MOSFET Q1 is off.

Diode D13 protects the circuit if the PV terminals are connected incorrectly. Diode D5 and fuse F1 protect the circuit if battery terminals are connected incorrectly. MOSFET Q2 controls the load. Load-side short-circuit protection is provided by the fuse F2. The high-side gate driver circuit U3 drives the main switching MOSFET.

Low-ohmic current sense resistors R6, R8 and R10 are used for current measurement. Resistor network R3 and R5 sense the PV voltage. Resistor network R4 and R7 sense the battery voltage.

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Fig 11. DC-DC buck-boost converter power electronics circuit schematics

# 5.2.4 MPT612 digital circuit

The MPT612 digital circuit is shown in <u>Figure 12</u>. The MPT612 controller U15 is the heart of the charge controller board. LEDs D16, D17 and D18 indicate the charge controller's status. NTC1 measures the ambient temperature. The clock circuit is formed by crystal X1 and capacitors (C42, C43). The reset circuitry is formed by resistor R72, capacitor C41 and switching diode D10. J6 is the UART and JTAG debug connector.

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# 5.2.5 Charge controller board power supply circuit

The board power supply circuit is shown in Figure 13. The switching regulator U9 takes battery voltage as the input for a 3.3 V ( $V_{DD(3V3)}$ ) regulated output supply. This 3.3 V supply is used for powering the MPT612 IC and rest of the circuitry. The low dropout regulator U10 is the core voltage for MPT612.

MOSFET switch M1 is used to switch off the power to the board during the standby condition. The battery voltage comparator U11A, PV voltage comparator U11D and overload comparator U11B with OR gate U12 forms the standby control circuit. The Output of PV voltage comparator signal is also used as interrupt signal to the MPT612 to wake it from the power-down state.



# 5.2.6 JTAG/UART add-on board circuit diagram

The optional JTAG/UART add-on board circuit is shown in <u>Figure 14</u>. This board is an add-on board which is used with the charge controller board for programming. U13 is the RS232-level connector IC. The UART port with additional level-shifted RST and EINT signals is used for ISP programming.

The JTAG connector J7 is used with the debugger. Jumper J9 is closed when JTAG is selected. Jumper J13 and J11 are used to select the ISP programming.



# 6. Charge controller reference system bill of materials

The charge controller reference system comprises two boards; the charge controller board and the JTAG/UART add-on board. The BOM for each board is described in <u>Table 3</u> and <u>Table 4</u>.

# 6.1 Charge controller board Bill Of Materials (BOM)

The charge controller board BOM is given in Table 3.

 Table 3.
 Charge controller board BOM

| Component   | Description   | Manufacturer's part<br>number | Manufacturer            |
|---|---|-------------------------------|-------------------------|
| C1, C2  | 4700 pF, 200 V, ceramic capacitor X7R<br>0805             | ECJ-2VB2D472K                 | Panasonic Corp.         |
| C3, C5  | 1000 $\mu\text{F},$ 50 V, electrolytic capacitor, low ESR | UHD1H102MHD                   | Nichicon Corp.          |
| C4, C7  | 680 $\mu\text{F},$ 35 V electrolytic capacitor KY RAD     | EKY-350ELL681MK20S            | United Chemi-Con Inc.   |
| C1, C13, C21, C24,<br>C31, C37, C38, C39,<br>C40, C41, C49, C50,<br>C55, C56, C57, C58,<br>C59, C60, C69, C70,<br>C71 | 0.1 μF, 50 V, ceramic capacitor                           | 08055C104MAT2A                | AVX Corp.               |
| C14   | 10 $\mu\text{F},$ 25 V, electrolytic capacitor            | UVZ1E100MDD                   | Nichicon Corp.          |
| C15, C16  | 10 $\mu$ F, 63 V, electrolytic capacitor                  | UVZ1J100MDD                   | Nichicon Corp.          |
| C18, C20, C22, C23,<br>C25, C26, C28, C29,<br>C30, C32, C36, C68  | 0.01 $\mu\text{F},$ 50 V, ceramic capacitor               | 08055C103MAT2A                | AVX Corp.               |
| C19   | 10 $\mu\text{F},$ 16 V, electrolytic capacitor, general   | UVZ1C100MDD                   | Nichicon Corp.          |
| C27, C62, C65   | 4.7 $\mu\text{F},$ 50 V, ceramic capacitor, X5R, 1206     | C1206C475K5PACTU              | Kemet Corp.             |
| C34, C35, C73   | 0.33 $\mu\text{F},$ 50 V, ceramic capacitor               | 08055C334MAT2A                | AVX Corp.               |
| C42, C43  | 22 pF, 50 V, ceramic capacitor                            | 08055A220KAT2P                | AVX Corp.               |
| C51   | 330 pF, 50 V, ceramic capacitor                           | 08055C331KAT2A                | AVX Corp.               |
| C52   | 2.2 $\mu\text{F},$ 16 V, ceramic capacitor                | 08055C104MAT2A                | AVX Corp.               |
| C53   | 47 $\mu\text{F},$ 25 V, electrolytic capacitor            | UVZ1E470MDD                   | Nichicon Corp.          |
| C54   | 680 $\mu\text{F},$ 10 V, electrolytic capacitor           | EEUFM1A681L                   | Panasonic Corp.         |
| C61   | 4700 pF, 1000 V, ceramic capacitor, X7R<br>1206           | C1206C472KDRACTU              | Kemet Corp.             |
| DR1, DR2, DR3, DR4,<br>R21, R28, R32, R53,<br>R67, R101, R111   | 10 k $\Omega$ , 5 %, $\frac{1}{8}$ W, 0805 SMD resistor   | MCR10EZHJ103                  | ROHM Co. Ltd            |
| D1, D7, D12   | fast recovery SMD diode                                   | ES1B                          | Fairchild Semiconductor |
| D2  | Schottky rectifier, $2 \times 20$ A, D2PAK                | STPS40L45CG                   | STMicroelectronics      |
| D5, D13   | 30 A, 100 V, ultra-fast diode, TO220                      | BYV42E-150                    | NXP Semiconductors      |
| D8  | 30 A, 100 V ultra-fast diode, TO220                       | BYV44-500                     | NXP Semiconductors      |
| D9  | 12 V, 0.5 W, SMD Zener diode                              | BZT52H-C12                    | NXP Semiconductors      |
| D10   | high speed switching diode, SOT23                         | MMBD4148                      | NXP Semiconductors      |

| Component  | Description   | Manufacturer's part<br>number | Manufacturer                          |
|--|---|-------------------------------|---------------------------------------|
| D11  | Schottky rectifier 60 V, 1 A, SOD323F                         | PMEG6010CEJ                   | NXP Semiconductors                    |
| D16  | 3 mm through hole; yellow LED                                 | HLMP-1719                     | Avago Technologies                    |
| D17  | 3 mm through hole; green LED                                  | HLMP-1790                     | Avago Technologies                    |
| D18  | 3 mm through hole; red LED                                    | HLMP-K150                     | Avago Technologies                    |
| D19  | 24 V, 0.5 W, SMD Zener diode                                  | BZT52H-C24                    | NXP Semiconductors                    |
| F1, F2   | 12 A high current fuse holder clips                           | 751.0056                      | Schurter Group                        |
| J6   | 10-way, dual row 2.54 mm pitch connector                      | SSW-110-01-T-D                | Samtec                                |
| J14  | 8-pin, side entry 5 mm, 300 V, 24 A terminal block            | 282856-8                      | Tyco Electronics                      |
| J15  | 10-way single row, 2.54 mm pitch connector                    | TSW-110-07-T-S                | Samtec                                |
| L1   | 85 μH, 25 A inductor  | -                             | EPCOS AG                              |
| L2, L3, L4, L5, L6, L8   | 120 $\Omega$ , 100 MHz, 500 mA; ferrite bead                  | EXC-3BP121H                   | Panasonic Corp.                       |
| L7   | 47 $\mu$ H, 1.5 A SMD shielded inductor                       | B82464G4473M                  | EPCOS AG                              |
| MOV1   | SMD MOV for surge protection                                  | SIOV-CN2220K25G               | EPCOS AG                              |
| M1, M5, M6   | P-channel MOSFET  | PMV65XP                       | NXP Semiconductors                    |
| NTC1   | 1.5 k $\Omega$ at 25 °C (radial) leaded NTC                   | 2381 640 63152                | Vishay Electronic                     |
| Q1, Q3   | N-channel Trench MOSFET                                       | PSMN8R2-80YS                  | NXP Semiconductors                    |
| Q2, Q4   | N-channel Trench MOSFET                                       | PSMN1R3-30YL                  | NXP Semiconductors                    |
| Q5   | NPN transistor 1 A  | PBSS8110Z                     | NXP Semiconductors                    |
| Q6, Q7, Q11  | NPN transistor, SW 600 mA, 40 V, SOT23                        | PMBT2222A                     | NXP Semiconductors                    |
| Q8, Q9, Q13  | NPN transistor, 1 A, 60 V SOT23                               | PBSS4160T                     | NXP Semiconductors                    |
| R1, R2   | 15 $\Omega,$ 5 %, $^{1}\!\!/_{4}$ W, 0805 SMD resistor        | ESR10EZPJ150                  | ROHM Co. Ltd                          |
| R3, R25, R29, R30,<br>R38, R42   | 68.1 kΩ, 1 %, $^{1}\!\!/_{8}$ W, 0805 SMD resistor            | MCR10EZHF6812                 | ROHM Co. Ltd                          |
| R4   | 27.4 kΩ, 1 %, $\frac{1}{8}$ W, 0805 SMD resistor              | MCR10EZHF2742                 | Yageo Corp.                           |
| R5   | 3.9 kΩ, 1 %, $\frac{1}{8}$ W, 0805 SMD resistor               | MCR10EZHF3901                 | Yageo Corp.                           |
| R6, R10  | 0.010 $\Omega$ , 1 %, 2 W, resistor, current sense            | MCS3264R010FER                | Ohmite Mfg. Co.                       |
| R7   | 4.7 kΩ, 1 %, <sup>1</sup> / <sub>8</sub> W, 0805 SMD resistor | MCR10EZHF4701                 | Yageo Corp.                           |
| R8   | $0.005~\Omega,$ 1 %, 2 W, resistor, current sense             | MCS3264R005FER                | Ohmite Mfg. Co.                       |
| R22, R33, R81, R82   | 20 kΩ, 5 %, $\frac{1}{8}$ W, 0805 SMD resistor                | MCR10EZHJ203                  | ROHM Co. Ltd                          |
| R23, R24, R26, R35,<br>R37, R45, R46, R55,<br>R64, R66, R78, R105,<br>R107 | 10 k $\Omega$ , 1 %, $\frac{1}{8}$ W, 0805 SMD resistor       | MCR10EZPF1002                 | ROHM Co. Ltd                          |
| R27, R40   | 1 k $\Omega$ , 1 %, $\frac{1}{8}$ W, 0805 SMD resistor        | MCR10EZHF1001                 | ROHM Co. Ltd                          |
| R31, R41   | 0 $\Omega$ , $\frac{1}{8}$ W, 0805 SMD resistor               | MCR10EZHJ000                  | ROHM Co. Ltd                          |
| R36, R39   | 5.1 k $\Omega$ , 1 %, $\frac{1}{8}$ W, 0805 SMD resistor      | MCR10EZHF5101                 | ROHM Co. Ltd                          |
| R44, R48   | 2.74 kΩ, 1 %, $\frac{1}{8}$ W, 0805 SMD resistor              | MCR10EZPF2741                 | ROHM Co. Ltd                          |
| R54, R60, R77, R104,<br>R123   | 100 k $\Omega$ , 1 %, $\frac{1}{8}$ W, 0805 SMD resistor      | MCR10EZPF1003                 | ROHM Co. Ltd                          |
| R56, R65, R118, R119   | 4.7 k $\Omega$ , 5 %, $\frac{1}{8}$ W, 0805 SMD resistor      | MCR10EZHJ472                  | ROHM Co. Ltd                          |
| R57, R76, R124   | 1 k $\Omega$ , 5 %, $\frac{1}{8}$ W, 0805 SMD resistor        | MCR10EZHJ102                  | ROHM Co. Ltd                          |
| AN10936  | All information provided in this document is subje            | ct to legal disclaimers.      | © NXP B.V. 2011. All rights reserved. |

#### Charge controller board BOM ... continued Table 3.

**Application note** 

| Component                       | Description  | Manufacturer's part<br>number | Manufacturer               |
|---------------------------------|--|-------------------------------|----------------------------|
| R58, R75                        | 2.2 k\Omega, 5 %, $ {}^{1\!\!/}_{\! 8}$ W, 0805 SMD resistor | MCR10EZPJ222                  | ROHM Co. Ltd               |
| R59                             | 18.0 kΩ, 1 %, $\frac{1}{8}$ W, 0805 SMD resistor             | MCR10EZPF1802                 | ROHM Co. Ltd               |
| R72, R100, R113,<br>R115        | 47 k $\Omega,$ 5 %, ${}^{1}\!\!/_{8}$ W, 0805 SMD resistor   | MCR10EZPJ473                  | ROHM Co. Ltd               |
| R79, R94                        | 2.2 kΩ, 1 %, $^{1}\!\!/_{8}$ W, 0805 SMD resistor            | MCR10EZPF2201                 | ROHM Co. Ltd               |
| R84, R86, R87, R98              | 100 $\Omega,$ 1 %, $^1\!\!/_8$ W, 0805 SMD resistor          | MCR10EZHF1000                 | ROHM Co. Ltd               |
| R93                             | 0.2 $\Omega,$ 1 %, $^{1}\!\!\!/_{4}$ W, 0805 SMD resistor    | MCR10EZHFLR200                | ROHM Co. Ltd               |
| R96, R110                       | 20.5 kΩ, 1 %, $\frac{1}{8}$ W, 0805 SMD resistor             | MCR10EZHF2052                 | ROHM Co. Ltd               |
| R97                             | 100 $\Omega,$ 5 %, $^1\!\!/_8$ W, 0805 SMD resistor          | MCR10EZPJ101                  | ROHM Co. Ltd               |
| R99                             | 12.4 kΩ, 1 %, $\frac{1}{8}$ W, 0805 SMD resistor             | MCR10EZHF1242                 | ROHM Co. Ltd               |
| R102, R103, R109,<br>R112, R120 | 1.0 M $\Omega$ , 5 %, $\frac{1}{8}$ W, 0805 SMD resistor     | MCR10EZPJ105                  | ROHM Co. Ltd               |
| R106, R116, R117                | 15 k $\Omega$ , 1 %, $\frac{1}{8}$ W, 0805 SMD resistor      | MCR10EZHF1502                 | ROHM Co. Ltd               |
| R108                            | 22 kΩ, 1 % SMD resistor                                      | MCR10EZHF2202                 | ROHM Co. Ltd               |
| R114                            | 2.0 MΩ, 1%, $\frac{1}{4}$ W, 1206 SMD resistor               | MCR18EZPF2004                 | ROHM Co. Ltd               |
| R121                            | 100 k $\Omega,$ 5 %, $^{1}\!\!/_{8}$ W, 0805 SMD resistor    | MCR10EZHJ104                  | ROHM Co. Ltd               |
| R122, R16                       | 33 $\Omega,$ 5 %, $^{1}\!\!/_{\!8}$ W, 0805 SMD resistor     | RMCF 1/10 33 5 % R            | Stackpole Electronics Inc. |
| SW2                             | switch TACT RA H = 1.24 mm, 160 GF                           | FSMRA2J                       | Tyco Corp.                 |
| U3                              | single channel high-side gate driver                         | IRS21171STRPBF                | International Rectifier    |
| U4, U5, U6, U11                 | quad, low voltage rail-to-rail op amp                        | LPV324M                       | National Semiconductor     |
| U9                              | 1.5 A, step-down switching regulator                         | MC33063ADR2G                  | On Semiconductor           |
| U10                             | 1.8 V, 200 mA, LDO   | TPS73018DBV                   | Texas Instruments          |
| U12                             | single 3 input OR gate                                       | 74LVC1G332GW                  | NXP Semiconductors         |
| U14                             | IC current monitor 3 %, SOT23-5                              | INA194AIDBVT                  | Texas Instruments          |
| U15                             | MPPT IC  | MPT612FBD48                   | NXP Semiconductors         |
| X1                              | 12 MHz, crystal, fundamental frequency                       | ECS-120-20-4XDN               | ECS Inc.                   |
| F1                              | 12 A, fast blow fuse, battery reverse protection             | PSF-12A                       | Protectron                 |
| F2                              | 10 A, fast blow fuse, battery reverse protection             | PSF-10A                       | Protectron                 |
| PCB                             | PCB, DS, 150 mm × 100 mm                                     | PCB                           | -                          |

# Table 3. Charge controller board BOM ...continued

# 6.2 JTAG/UART add-on board Bill Of Materials (BOM)

The JTAG/UART add-on board BOM is given in Table 4.

### Table 4. JTAG/UART add-on board BOM

| Component  | Description   | Manufacturer's part<br>number | Manufacturer       |
|--|---|-------------------------------|--------------------|
| C44, C45, C46, C47,<br>C48                                       | 0.1 $\mu\text{F},$ 50 V, ceramic capacitor              | 08055C104MAT2A                | AVX Corp.          |
| D14, D15   | high-speed switching diode, SOT23                       | MMBD4148                      | NXP Semiconductors |
| J6   | 10-way, dual row 2.54 mm pitch berg connector (20 pin)  | TSS-110-01-L-D                | Samtec             |
| J7   | 10-way, dual row 2.54 mm pitch berg connector (20 pin)  | TSW-110-07-T-D                | Samtec             |
| J9   | 2 pin, 2.54 mm jumper for JTAG selection                | 22032021                      | Molex Inc.         |
| J10  | D-sub connector 9 pin female vertical                   | 171-009-213R001               | Norcomp Inc.       |
| J11, J13   | 2 pin, 2.54 mm, jumper for ISP selection                | 22032021                      | Molex Inc.         |
| Q10, Q12   | NPN SW 600 mA, 40 V transistor SOT23                    | PMBT2222A                     | NXP Semiconductors |
| R49, R50, R51, R52,<br>R60, R61, R62, R63,<br>R69, R70, R71, R73 | 10 k $\Omega$ , 5 %, $\frac{1}{8}$ W, 0805 SMD resistor | MCR10EZHJ103                  | ROHM Co. Ltd       |
| R74, R80   | 33 k $\Omega,$ 5 %, $^1\!\!/_8$ W, 0805 SMD resistor    | RC0805JR-0733KL               | ROHM Co. Ltd       |
| U13  | driver/receiver RS-232 1-CH 16TSSOP                     | MAX3221CPWR                   | Texas Instruments  |
| PCB  | PCB, DS, 75 mm $\times$ 40 mm                           | -                             | -                  |

# 7. Component selection

# 7.1 PV System parameters

The following parameters must be considered for the major components in the design of the MPPT charge controller reference system:

- PV panel rating: 100 W at STC
- PV voltage range: up to 27 V
- MPP voltage range: 10 V to 21 V
- Maximum input current: 6 A
- Resistance across the panel cables: 400 mΩ
- MPP voltage on board terminals: 7.5 V to 18.5 V (after 2.5 V maximum drop across the cable)

# 7.2 Major components

The major MPPT charge controller reference system components are listed below:

- Frequency of DC-DC converter operation; see <u>Section 7.2.1</u>
- Inductor; see <u>Section 7.2.2</u>
- Input bulk capacitor; see <u>Section 7.2.3</u>
- Switching MOSFET; see <u>Section 7.2.4</u>

- Output diode; see Section 7.2.5
- Output capacitor; see Section 7.2.6
- Thermal pads; see Section 7.2.7

### 7.2.1 Frequency of DC-DC converter operation

The optimum frequency for DC-DC converter operation was arrived at after keeping in mind the trade-off between switching losses, inductor size and inductor losses. The higher the switching frequency, the smaller the inductor size. However, the switching loss in the switching device and core loss in the inductor are directly proportional to the operating frequency. In this design, the converter switching frequency is fixed at 20 kHz based on the experimental results which ensures both switching loss and inductor size are optimized.

### 7.2.2 Inductor

•  $I_{L(AV)} = I_0 / (1 - \delta)$ 

Where I<sub>O</sub> is the output current and  $\delta$  is the duty cycle. In buck-boost mode, the maximum duty cycle is 60 %.

- $I_{L(AV)} = 6 / 0.4 = 15 A$
- $I_{L(pk)} = (I_0 / 1 \delta) + \Delta I_L / 2 = 18.75$  A; where  $\Delta I_L$  is the inductor ripple current
- V<sub>I</sub> = 19 V
- δ = 0.8 %
- $\Delta I_L = 0.3 * I_{L(AV)}$
- f<sub>osc</sub> = 20 kHz
- $L_{min} = V_I \times \delta / (f_{osc} \times \Delta I_L) = 76 \ \mu H$

The inductor selected for proto stage is ~85  $\mu$ H/20 A. Also refer to:

- www.coilcraft.com/apps/selector/selector\_1.cfm
- schmidt-walter.eit.h-da.de/smps\_e/ivw\_smps\_e.html

# 7.2.3 Input bulk capacitor

The input capacitor is mainly selected on its ESR value and on the RMS current rating to support the high current changes on the input. Low ESR capacitors are recommended to minimize the input voltage ripple and interference with other circuits in the system.

- $C_{I(min)} = (I_I * t_{on}) / \Delta V_I$
- I<sub>I</sub> = 6 A
- t<sub>on</sub> = 25 μS (50 % δ)
- input ripple voltage (ΔV) = 0.2 V
- C<sub>I(min)</sub> = (6 \* 25) / 0.2 = 750 μF
- ESR =  $\Delta V_1 / (I_1 / \delta) = 0.2 / (6 / 0.5) = 16 \text{ m}\Omega$

To reduce the ESR, two 1000  $\mu$ F, 50 V capacitors are used in parallel. Nichicon part number UHD1H102MHD with ESR 21 m $\Omega$ , rated ripple current 3.01 A.

# 7.2.4 Switching MOSFET

- Peak current in the MOSFET I<sub>SW(pk)</sub> = I<sub>L(pk)</sub> = 18 A
- V<sub>I</sub> at some cases can go up to 21 V
- $V_{DS(max)} = V_1 + V_0 = 21 V + 16 V = 37 V$
- Select a MOSFET with a  $V_{DS}$  greater than 37 V and  $I_{DS}$  greater than 15 A.

The MOSFET selected is NXP part number PSMN8R2-80YS: 82 A  $I_{DS(max)}$ , 8.2 m $\Omega$  R<sub>DS(on)</sub>, 80 V (V<sub>DS</sub>), Loss Free PACKage (LFPACK) SMD MOSFET.

# 7.2.5 Output diode

- $I_{D(AV)} \ge I_0 = 6 \text{ A}$
- $I_{D(pk)} = I_{L(pk)} = 18 \text{ A}$
- $V_{RRM} \ge V_1 + V_0 = 37 V$

The efficiency of the converter depends on the diode  $V_F$  (in buck-boost operation), so a diode with a low  $V_F$  should be selected.

The Schottky diode selected is STPS40L45CG:

- 45 V, 40 A
- V<sub>F</sub> = 0.45 V

### 7.2.6 Output capacitor

$$\frac{C_O \ge I_{O(max)} \times ((V_O + V_F) \div ((V_{I(min)} - V_{sw}) + (V_O + V_F)))}{f_{osc} \times \Delta V_{OC}}$$
(1)

- I<sub>O(max)</sub> = 6 A
- V<sub>O</sub> = 16 V
- V<sub>F</sub> = 0.45 V
- V<sub>I(min)</sub> = 8 V
- V<sub>sw</sub> = 0.4 V
- f<sub>osc</sub> = 20 kHz
- ΔV<sub>OC</sub> = 200 mV
- $C_O \ge 1028 \ \mu F$
- ESR =  $\Delta V_O / I_{sw(peak)}$  = 11.1 m $\Omega$

Select two output electrolytic capacitors of 680  $\mu$ F, 35 V with an ESR of less than 25 m $\Omega$ . Place them in parallel so that effective ESR is less than 11.5 m $\Omega$ .

The selected component is a Nichicon UHD1V680MHD.

- ESR 21 m $\Omega$
- Rated ripple current is 2.36 mA

# 7.2.7 Thermal pads

Maximum junction temperature  $(T_{j(max)}) = P_{AV} \times R_{th(tot)} + T_{amb}$ 

Where  $P_{AV}$  = average power;  $R_{th(tot)}$  = total thermal resistance and  $T_{amb}$  = ambient temperature.

The thermal resistance of the PCB in FR4 material (2 oz. copper) is 90 °C/W for 1 cm<sup>2</sup>. However, more thermal pads are required to minimize the MOSFET junction temperature. One option is to add copper to be on the safer side. The PCB R<sub>th</sub> is considered to be 300 °C/W with 70 micron for calculation purposes. The maximum device junction temperature is limited to 100 °C. The ambient temperature is considered to be 50 °C.

# 7.2.7.1 Thermal pad for D2PAK diode

- Power dissipation at 2.88 W maximum (0.48 V V<sub>F</sub> and 6 A average current)
- Minimum pad area required: 31 mm × 31 mm on both sides
- R<sub>th(j-a)</sub> = 30 °C/W
- Temperature increase = power dissipated × R<sub>th(i-a)</sub>
- Temperature increase = 2.88 W × 30 °C = 86 °C

The above  $R_{th(j-a)}$  is based on a copper thickness of 35 micron. However, with a 75 micron thickness of copper, the  $R_{th(j-a)}$  is further reduced. PCB thermal pad copper area is calculated using <u>Equation 2</u>:

$$Area = \frac{P_d \times R_{th(pcb-a)}}{(T_j - T_{amb} - P_d \times (R_{th(j-c)} + R_{th(c-pcb)}))}$$
(2)

- P<sub>d</sub> = power dissipated in the device in W
- R<sub>th(pcb-a)</sub> = thermal resistance of a 1 cm<sup>2</sup> PCB surface to ambient in °C/W
- T<sub>i</sub> = maximum or desired junction temperature in °C
- T<sub>amb</sub> = ambient temperature in °C
- R<sub>th(i-c)</sub> = thermal resistance from junction to case in °C/W
- R<sub>th(c-pcb)</sub> = thermal resistance from case to PCB surface in °C/W

Equation 2 calculates the total PCB copper area needed to keep the junction temperature within the defined limits. The thermal pad area required for a single-sided PCB is calculated. If both sides of the PCB are used as a thermal pad then this value is divided by 2. If thermal vias are not used, it is assumed that the heat is mainly dissipated on one side of the board. However, the area on both sides of the PCB can be counted when adequate thermal vias are used.

### 7.2.7.2 MOSFET thermal pad calculation

The minimum thermal pad area required for MOSFETs is as follows:

Q1; part number: PSMN8R2-80YS

- R<sub>DS(on)</sub> at 100 °C is 13.8 mΩ, current = 6 A
- Power: 1.5 W
- Pad area required: 25 mm × 25 mm on both sides
- Make an additional pouring because this is the switching device

Q2; part number: PSMN1R3-30YL

- R<sub>DS(on)</sub> at 100 °C is 2.5 mΩ, current = 10 A
- Power: 250 mW
- Pad area required: 10 mm × 10 mm on both sides

Q3; part number: PSMN8R2-80YS

- R<sub>DS(on)</sub> at 100 °C is 13.8 mΩ, current = 6 A
- Power: 500 mW
- Pad area required: 13 mm × 13 mm on both sides

Q4; part number: PSMN1R3-30YL

- $R_{DS(on)}$  at 100 °C is 2.5 m $\Omega$ , current = 6 A
- Power: 200 mW (maximum)
- Pad area required: 8 mm × 8 mm on both sides

Refer to Equation 2 for the calculation of the pad area and AN10874 LFPAK MOSFET thermal design guide for detailed information on specifying PCB materials.

# 8. System test plan

This section describes the tests which are performed to demonstrate that the MPPT charge controller reference system meets the specifications provided in <u>Table 2 on page 9</u>.

- Test cases are decided based on requirements for demonstration to be completed in 10 hours
- When possible and acceptable, to speed up the testing, DC power supplies can replace PV panel and battery
- Load means electronic DC-load
- Destructive tests (marked as D in the test title) are performed at the end of the test cycle (as required)
- Test set-up combination abbreviations are described in Table 5.

### Table 5. Test set-up abbreviations

| Name | Description  |
|------|--|
| S    | DC-supply  |
| Р    | PV panel   |
| Ν    | NXP charge controller  |
| В    | battery with a maximum charge of 20 Ah to charge the battery in the short time available |
| E    | Electronic DC-load   |

• Infrastructure required

### Table 6. Infrastructure requirements

| Description   | Limits   |
|---|--|
| DC supply   | 20 V and 6 A maximum   |
| DC supply maximum   | 20 V and 20 A maximum  |
| Electronic DC-load (non-inductive)                                  | up to 20 A and 20 V  |
| PV panel with cables to charge<br>controller under test             | 70 W or 80 W   |
| Pre-charged 12 V lead-acid battery                                  | 20 Ah maximum  |
| 4-channel data logger   | two for voltages up to 20 V and two for currents up to 20 A $$ |
| Current meter   | 1 A with 1 mA accuracy minimum; 0 A to 20 A                    |
| Oscilloscope  | to measure 500 ms time duration                                |
| PC/laptop with MS-Excel and other general purpose software packages | -  |

| Test                             | Test description  | Set-up | Expected result and behavior  | Time<br>(± min) |
|----------------------------------|---|--------|---|-----------------|
| Functional                       |   |        |   |                 |
| Boost and buck<br>charging       | connect variable DC supply to PV<br>terminal and battery at 14 V to the<br>charge controller. Increase input voltage<br>from 11 V to 19 V in steps of 2 V.<br>Measure input and output voltages and<br>currents.  | SNB    | <b>boost mode:</b> when the input voltage<br>is less than the battery voltage,<br>charging current flows to the battery<br><b>buck mode:</b> when the input voltage is<br>less than the battery voltage, charging<br>current flows in to the battery  | 10              |
| Standby current                  | connect charge controller to the battery<br>without PV or load and measure battery<br>discharge current flowing into charge<br>controller.  | NB     | should be below 10 mA   | 10              |
| MPP peak latching                | connect PV panel output to charge<br>controller and battery at 12 V to the<br>battery terminals. Measure input and<br>output voltages and currents through<br>data logger for 15 minutes minimum.<br>Plot input power (Watts) as a function of<br>time.   | PNB    | the PV panel power should continue<br>to latch to the panel's MPP under the<br>given environmental conditions.  | 30              |
| MPP tracking with shadowing      | repeat the above test with partial shadowing of the panel ( $1/5^{th}$ to $1/4^{th}$ )  | PNB    | the PV panel power should continue<br>to latch to the panel's MPP under the<br>given environmental conditions.  | 30              |
| Charging cycle<br>implementation | connect DC power supply at 17 V and<br>5 A, and pre-charged 20 Ah lead-acid<br>battery just below boost charge on<br>voltage (12.4 V) to charge controller.<br>Charge battery at 4 A CC until float<br>stage (fully charged) and track battery V<br>and I. Plot charging cycle to verify the<br>charging cycle control algorithm<br>functionality. Observe the battery<br>indicator light status. | SNB    | <ul> <li>battery charge cycle should be:</li> <li>CC mode: boost starts at 12.6 V and ends at 15.3 V.</li> <li>CV mode: float V = 13.6 V, battery light indication should be: green blinking: while charging green on: battery is fully charged and input supply present</li> </ul>                                 | 120             |
| Battery status<br>indication     | connect a DC supply with reverse<br>current blocking diode and minimal load<br>(to arrest any overshoot of inductor<br>voltage) at battery terminal of the<br>charge controller. Connect load to the<br>load terminal. Increase voltage from<br>10.8 V to 16 V and observe the battery<br>light status  |        | <ul> <li>battery light indication should be:</li> <li>green blinking: while charging</li> <li>green on: when battery is fully</li> <li>charged</li> <li>yellow blinking: when battery is Low</li> <li>(just above 10.8 V)</li> <li>red: when battery voltage reaches</li> <li>10.8 V and load is cut-off</li> </ul> | 10              |
| Load status<br>indication        | connect battery and electronic DC load<br>to charge controller. Increase load<br>current from 0 A to 15 A and observe<br>load indication lights.  | NBE    | no indication until the load current is<br>within 12.5 A and red above 12.5 A<br>and load is cut-off  | 20              |

# Table 7. System tests overview

See <u>Table 5</u> for the test set-up abbreviation definitions.

| Test  | Test description   | Set-up | Expected result and behavior   | Time<br>(± min) |
|---|--|--------|--|-----------------|
| Protection  |  |        |  |                 |
| PV reverse current<br>flow prevention   | connect a DC voltage of 12 V to battery<br>terminals on the charge controller with<br>no load at the load terminals. Connect<br>electronic DC load at PV terminals.<br>Decrease load from maximum to<br>minimum to simulate PV acting as load<br>to battery. Observe current flow to the<br>DC load.   | SNBE   | no current should flow into the load   | 20              |
| Battery low load<br>disconnection when<br>PV is not present<br>(MCU in standby) | connect DC load to the charge controller<br>and DC supply of 12 V to battery<br>terminals. Decrease DC supply voltage<br>to below 10.8 V slowly. Observe load<br>status.   | NBE    | the load should be disconnected and load light should turn red when battery voltage is at 10.8 V           | 10              |
| Battery low load<br>reconnection when<br>PV is not present<br>(MCU in standby)  | connect DC load to the charge controller<br>and DC supply to battery terminals.<br>Increase supply from 12 V to 12.5 V<br>slowly. Observe load status.   | SNBE   | the load should be reconnected and<br>load light should change from red to<br>off state at 12.2 V          | 5               |
| Battery low load<br>disconnection when<br>PV is present (MCU<br>active)         | connect DC load to the charge controller<br>and DC supply of 12 V to battery<br>terminals. Decrease DC supply voltage<br>to below 10.8 V slowly. Observe load<br>status.   | NBE    | the load should be disconnected and<br>the load light should turn red when<br>battery voltage is at 10.8 V | 5               |
| Battery low load<br>reconnection when<br>PV is present (MCU<br>active)          | connect DC load to the charge controller<br>and DC supply to battery terminals.<br>Increase supply from 12 V to 12.5 V<br>slowly. Observe load status.   | NBE    | the load should be reconnected and load light should change from red to off-state at 12.2 V                | 5               |
| Load cut-off due to<br>overload   | connect battery and electronic DC load<br>to charge controller and increase load<br>current to 8 A slowly. Connect<br>oscilloscope and observe load current<br>and voltage.  | NBE    | after 500 ms, the load should be<br>disconnected and the load light<br>should turn red                     | 10              |
| Efficiency  |  |        |  |                 |
| Converter efficiency<br>in buck-boost mode                                      | connect DC supply and DC load to the<br>charge controller. Vary the input voltage<br>between 12 V and 20 V in such a way to<br>set input power at 5 W intervals from<br>30 W to 80 W and note down output<br>voltage and current. Calculate efficiency<br>(output wattage/input wattage). Plot<br>efficiency as a function of input wattage.<br><b>Remark:</b> This test can be run only if the<br>debug option is selected during the<br>initial setup. | SNE    | efficiency should be between 92 %<br>minimum and 94 % maximum over<br>the input range                      | 60              |

### Table 7. System tests overview

See Table 5 for the test set-up abbreviation definitions.

### Table 7. System tests overview

See Table 5 for the test set-up abbreviation definitions.

| Test   | Test description   | Set-up | Expected result and behavior                                       | Time<br>(± min) |
|--|--|--------|--|-----------------|
| Converter efficiency<br>in buck mode                         | DC supply and DC load to the charge<br>controller. Make the system operate in<br>buck mode only through software. Vary<br>the input voltage between 12 V and<br>20 V in such a way to set input power at<br>5 W intervals from 0 W to 80 W and note<br>down output voltage and current.<br>Calculate efficiency (output<br>wattage/input wattage). Efficiency as a<br>function of input wattage.<br><b>Remark:</b> This test can be run only if the<br>debug option is selected during the<br>initial setup. | SNE    | efficiency should be 98 % minimum                                  | 10              |
| Destructive  |  |        |  |                 |
| Battery reverse<br>connection<br>protection<br>(destructive) | connect DC supply at 17 V and 3 A and<br>battery in reverse (battery +ve to charge<br>controller –ve and vice versa) polarity to<br>charge controller.   | NBE    | battery fuse should blow   | 10              |
| Load cut-off due to<br>short-circuit<br>(destructive)        | connect 13.8 V supply to battery terminals. Short the load terminals and observe load and load side fuse.  | NBE    | load should be cut-off, fuse should blow and red light should glow | 10              |
|  | Miscellaneous such as the explanation, Q & A during testing  | -      | -  | 60              |
| Total duration   |  |        |  | 435             |

# 9. Benchmarking strategy

The MPPT charge controller reference system was benchmarked against the best charge controllers on the market.

Two identical test set-ups were made

- one for an MPT612-based MPPT charge controller reference design
- the other for the charge controller against which the reference design is bench marked

Benchmarking was also done for two types of panels:

- $P_{MPP} = 80 \text{ W}, V_{MPP} = 17 \text{ V}, I_{MPP} = 4.71 \text{ A}, I_{sc} = 5.39 \text{ A} \text{ and } V_{OC} = 21.20 \text{ V} \text{ at STC}$
- $P_{MPP} = 70 \text{ W}, V_{MPP} = 17 \text{ V}, I_{MPP} = 4.12 \text{ A}, I_{sc} = 4.72 \text{ A} \text{ and } V_{OC} = 21.20 \text{ V} \text{ at STC}$

70 Ah, 12 V, lead-acid battery was used in all the set-ups. A data logger was used for recording PV voltage/current and battery voltage/current.

Benchmarking criteria/parameters were as follows:

- Cumulative ampere hour (Ah) flowing into the battery from the charge controllers under identical environmental and experimental test conditions
- Percentage difference in Ah of the charge controllers

# **10.** System test and benchmarking results

All the system tests mentioned in <u>Table 7</u> were performed and the expected results obtained.

The benchmarking results were captured and <u>Figure 15</u> shows the enhanced performance provided by the MPT612-based MPPT charge controller reference board when compared to other charge controllers on the market.



# 11. Steps for evaluating the charge controller reference system

This section describes the steps needed to evaluate the charge controller reference system. The reference system has a sample charge controller application programmed in to the MPT612's flash memory. This sample charge controller application conforms to the parameters set in Table 2 on page 9.

# **11.1 Testing functionality**

The charge controller board can be used to run all the tests in <u>Table 6 "Infrastructure</u> requirements" on page 31 except the open-loop efficiency tests. The set of steps is as follows:

1. Connect the external load terminal to the L1+/L2+ and L1-/L2- terminals of the reference system ensuring correct polarity.

- Connect 12 V battery terminal to the BAT+ and BAT- terminals of the reference system ensuring correct polarity. The battery should meet the specification described in Section 4.1 on page 9.
- 3. Connect PV input to the PV+ and PV– terminal of MPT612 reference board. The PV should conform to the specification described in <u>Section 4.1 on page 9</u>.
- 4. The system function is indicated by the LEDs D16, D17 and D18. <u>Table 8</u> shows the LED status for different system functions.
- 5. When the PV terminals are connected, the system starts booting, indicated by the LEDs D16, D17 and D18 (if sufficient PV power is available).
- Measure PV voltage, PV current, battery voltage and battery current, using a multi-meter. The values will vary depending on the maximum power generated from the PV panel.
- 7. When sufficient PV power is available, the charge controller tracks the MPP, charges the battery and supplies power to the loads after 10 s.

### Table 8.LED status indications

| Indication      | Value                                    |
|-----------------|--|
| Green on        | battery is charging                      |
| Green blinking  | battery fully charged                    |
| Yellow blinking | battery is low                           |
| Red on          | battery low, cut-off or overload cut-off |
| All LEDs off    | system is in standby                     |

# 11.2 Testing open loop efficiency

The JTAG/UART add-on board is needed for the open-loop efficiency tests. The steps are as follows:

- 1. Connect JTAG/UART add-on board to the charge controller board's J6 port.
- Connect UART DB9 connector of the COM port of the PC to J10 of the JTAG/UART add-on board.
- 3. Open a terminal application on the PC (HyperTerminal or TeraTerm) and configure the following settings in that application:
  - a. Baud rate = 38400
  - b. Data bits = 8
  - c. Stop bits = 1
  - d. Flow control = None
  - e. Parity = None
- 4. Connect the external load terminal to the L1+/L2+ and L1-/L2- terminals of the reference system ensuring the correct polarity.
- Connect 12 V battery terminal to the BAT+ and BAT- terminals of the reference system ensuring the correct polarity. The battery should meet the specification described in Section 4.1 on page 9.
- Connect PV input to the PV+ and PV- terminal of MPT612 reference board. The PV should meet the specification described in <u>Section 4.1 on page 9</u>.

- 7. The application, present in the charge controller board waits for 10 seconds for a key to be pressed on the console:
  - a. When a key is pressed, it displays a menu on the console for the open-loop efficiency tests. The user can see the results on the console.
  - b. When a key is not pressed, the charge controller functionality is executed.
- 8. The system function is indicated by the LEDs D16, D17 and D18. <u>Table 8</u> shows the LED status for different system functions.
- 9. When the PV terminals are connected, the system starts booting, indicated by LEDs D16, D17 and D18 (if there is sufficient PV power is available).
- Measure the PV voltage, PV current, battery voltage and battery current, using a multi-meter. The values will vary depending on the maximum power generated by the PV panel.
- When sufficient PV power is available, the output of the sample charge controller application program is displayed on the PC's terminal application (HyperTerminal or TeraTerm).

**Remark:** The following output is only a sample and can differ from system to system. In addition, the connected PV, battery and load parameters will have an effect on the displayed values.

```
1
    *****
2
3
    MPT612 Sample Charge controller Application
4
    v1.0
    5
6
7
    SWCONV BOOST
8
    Waiting for minimum power to be present.....
    Scanning => full
9
10
     Prtrb
11
12
    *MPP LATCHED: Vmpp(mV) = 16101
13
14
       Prtrb
15
    *MPP LATCHED: Vmpp(mV) = 15992
16
17
       Prtrb
18
    *MPP LATCHED: Vmpp(mV) = 15956
19
20
21
    SWCONV BUCK
22
       Prtrb
23
    *MPP LATCHED: Vmpp(mV) = 16177
24
25
       Prtrb
26
27
    *MPP LATCHED: Vmpp(mV) = 16439
28
       Prtrb
29
30
    *MPP LATCHED: Vmpp(mV) = 16613
```

31 Prtrb
32
33 \*MPP LATCHED: Vmpp(mV) = 16468
34 Prtrb

# 12. Steps to link and test new applications

To learn how easy it is to link and test new applications please refer to the MPT612 SW development kit at <u>www.nxp.com/solar/</u>.

# 13. Abbreviations

| Table 9.         | Abbre | viations                                    |
|------------------|-------|---|
| Acronym          |       | Description                                 |
| ADC              |       | Analog-to-Digital Converter                 |
| API              |       | Application Programming Interface           |
| ESR              |       | Equivalent Series Resistance                |
| FIFO             |       | First In, First Out                         |
| GPIO             |       | General Purpose Input/Output                |
| I <sup>2</sup> C |       | Inter-Integrated Circuit                    |
| IRQ              |       | Interrupt Request                           |
| ISP              |       | In-System Programming                       |
| LDO              |       | Low DropOut regulator                       |
| MCU              |       | MicroController Unit                        |
| MOV              |       | Metal-Oxide Varistor                        |
| MPPT             |       | Maximum Power Point Tracking                |
| NTC              |       | Negative Temperature Coefficient            |
| PLL              |       | Phase-Locked Loop                           |
| PV               |       | PhotoVoltaic                                |
| PWM              |       | Pulse-Width Modulator                       |
| RISC             |       | Reduced Instruction Set Computer            |
| SMD              |       | Surface Mounted Device                      |
| SPI              |       | Serial Peripheral Interface                 |
| SRAM             |       | Static Random Access Memory                 |
| SSP              |       | Synchronous Serial Port                     |
| STC              |       | Standard Test Conditions                    |
| UART             |       | Universal Asynchronous Receiver/Transmitter |

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